## NV20, 4MX16 DDR, RGB, EXTERNAL DVI-I, TV-DOWN, TV IF , AGP4X PCI DEVICE ID 0X0=0X200 FOR NV20.

NVVDD SET TO: 1.52V FBVDD SET TO: 3.47V FBVDDQ SET TO: 2.59V

### HISTORY REVISION:

X00: Based on P50-A06 - See change list in 149- file. - Set FBVDDQ=2.59V

# P50-A07-X01:

- Changed all memory clk/clk# diff pair resistors to 68R 5% (from 47R)

P50-A08:

X04: Delay PLL\_VDD to come up after NVVDD.

X05: Added 1UF accross R257.

X06: Removed X04-5 above, added a switcher generated PLL delay option.

- SSENA cap for 2nd SW changed to 1UF.

- A05 si, NVVDD-1.52V

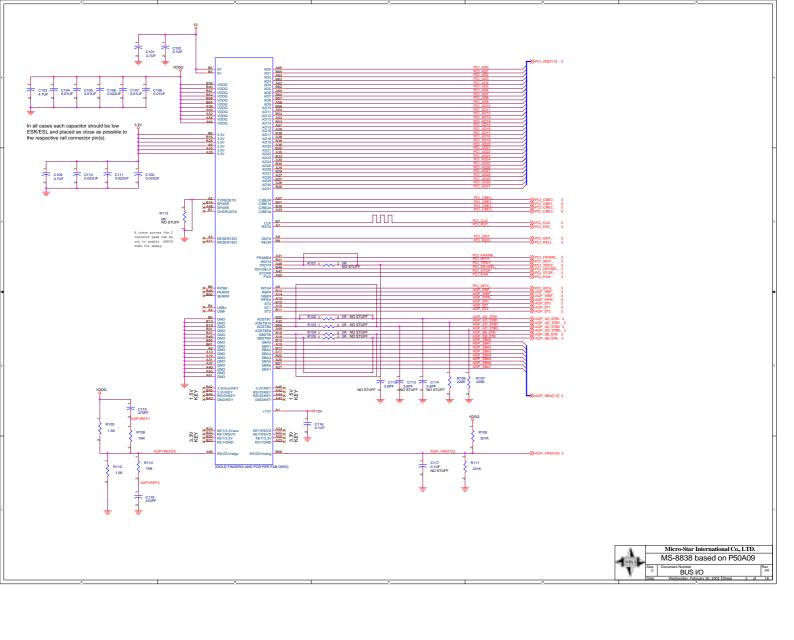
P50-A09:

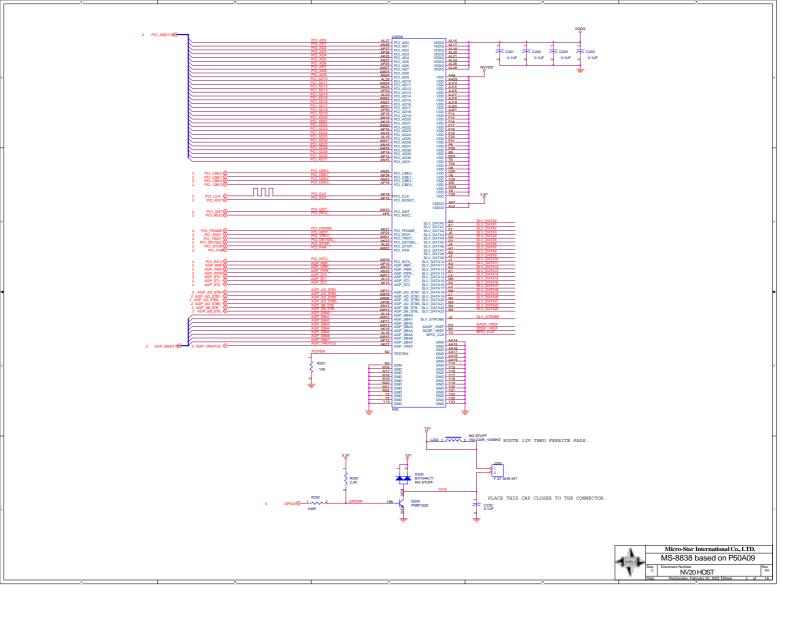
X02: Changed PLL VDD and DAC VDD to be gated by Fet controlled by FBVDD power good signal.

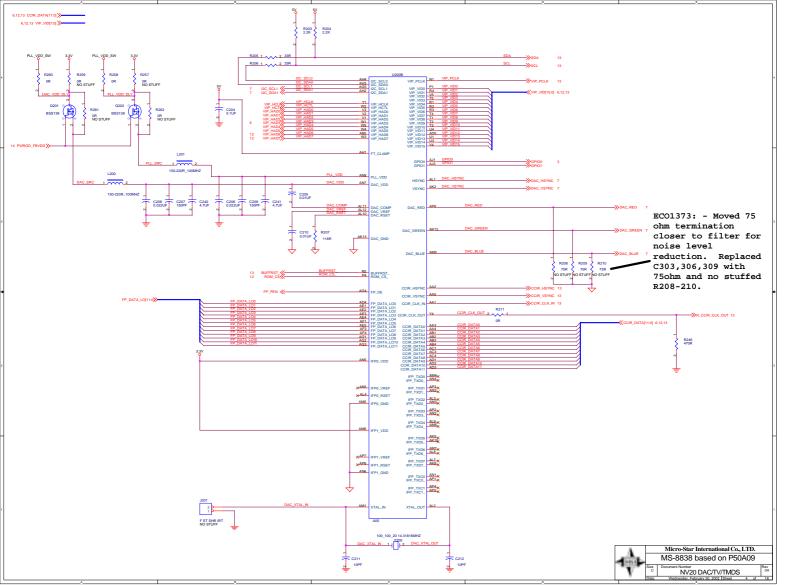
X03: Added option to pull up power good to 12V

EC01235: - Changed R841 PU to 10K (from 4.7K)

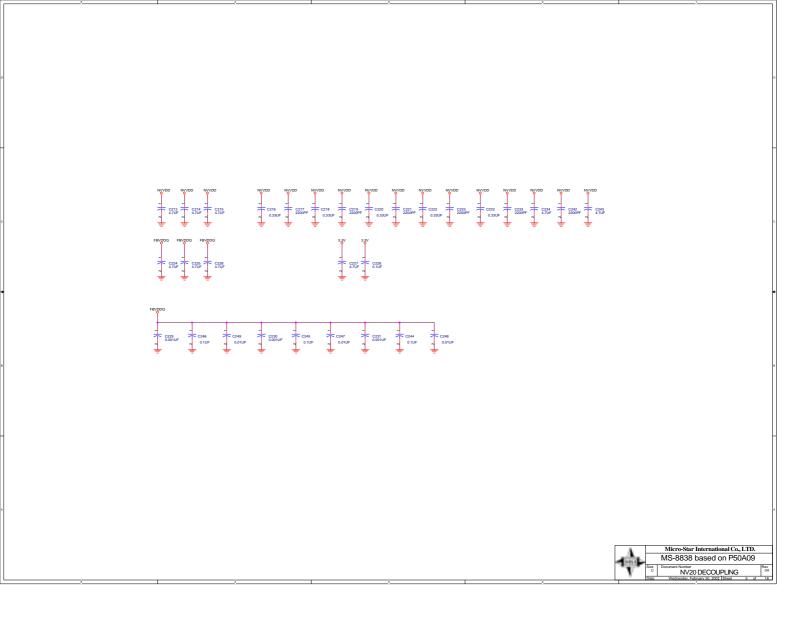
ECO1373: - Moved 75 ohm termination closer to filter for noise level reduction. Replaced C303,306,309 with 75ohm and no stuffed R208-210.

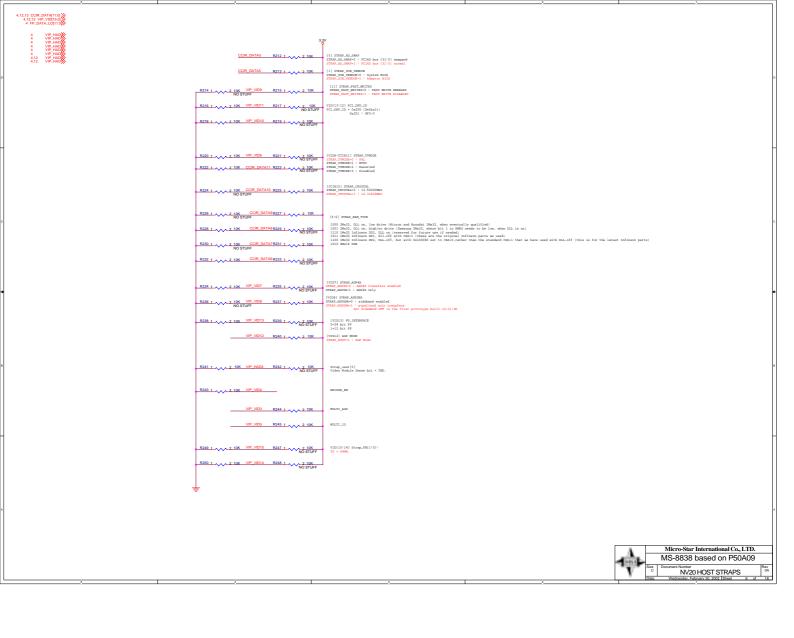


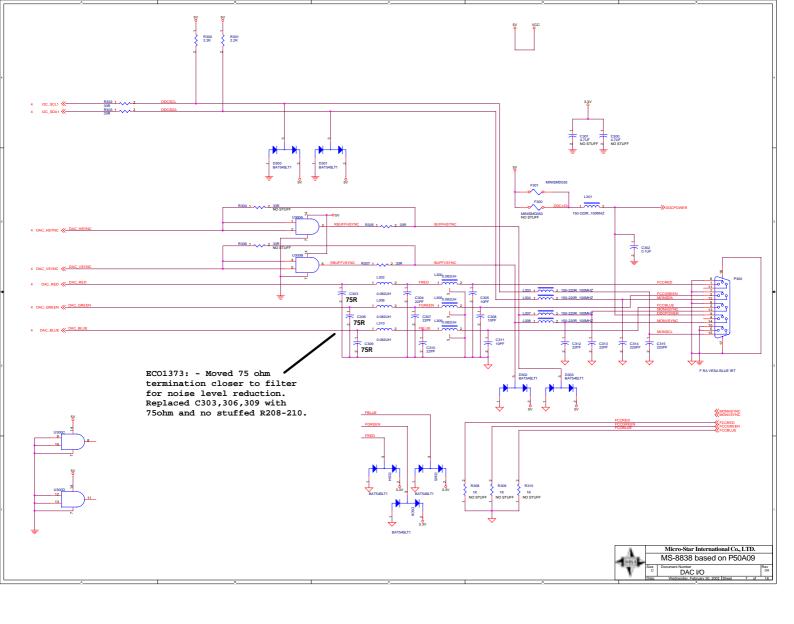


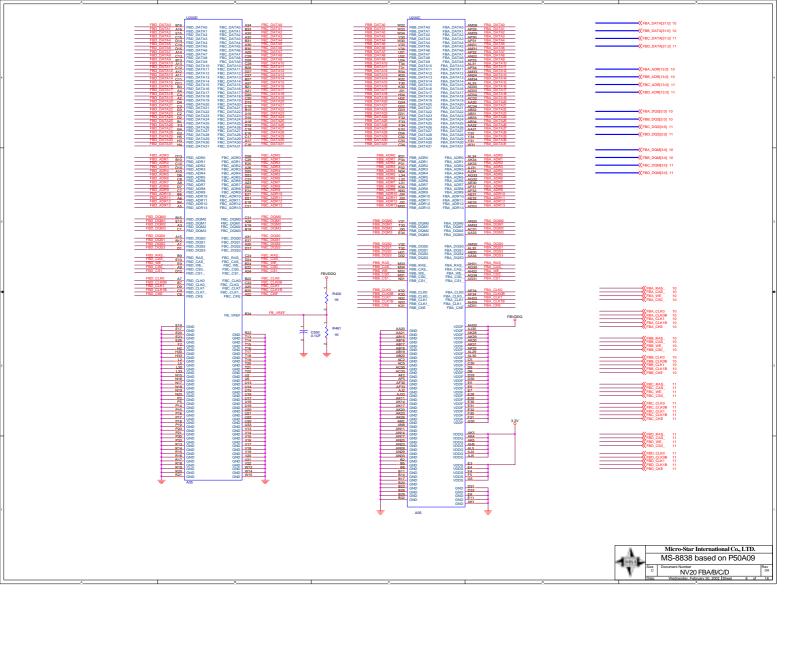


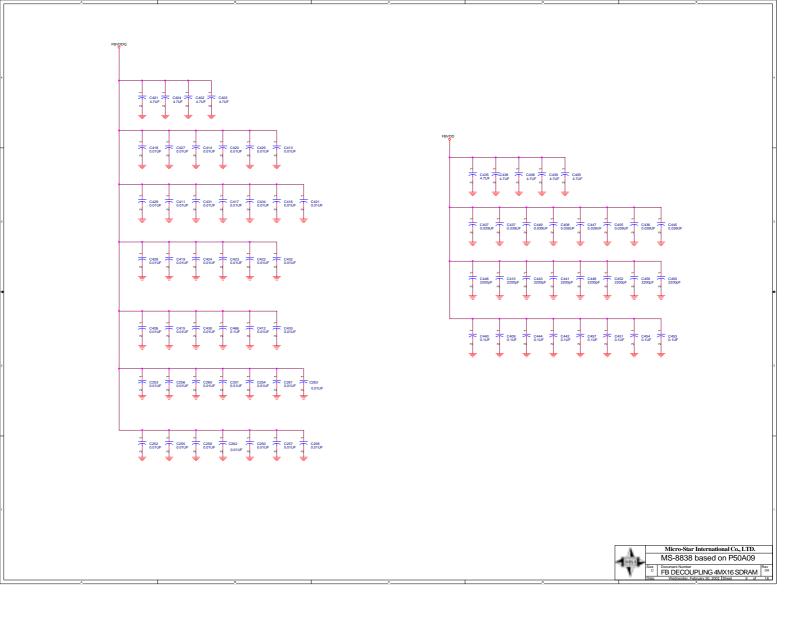
Use thick (non-impedance controlled) traces on XTALIN/OUT

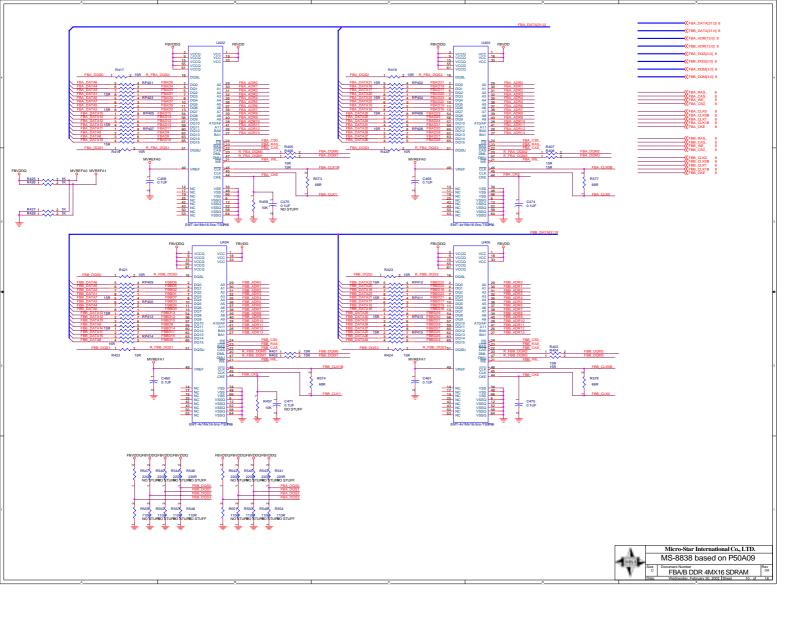


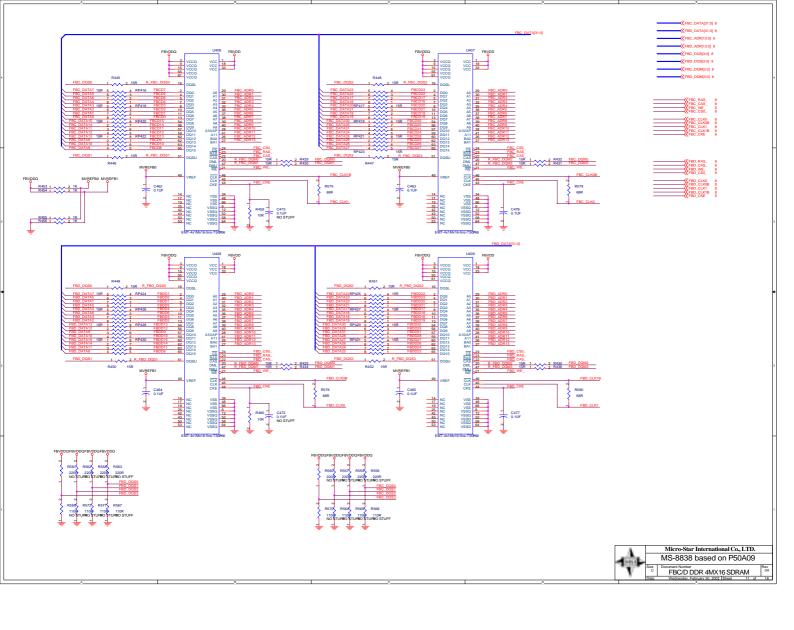


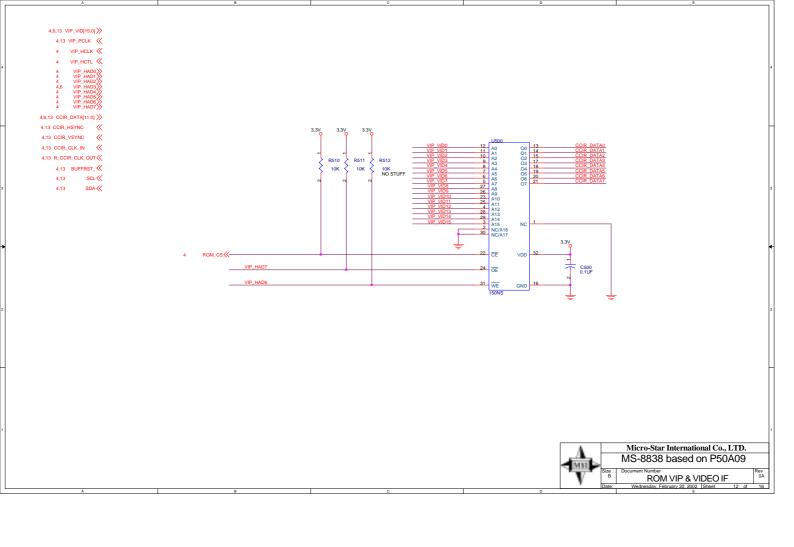


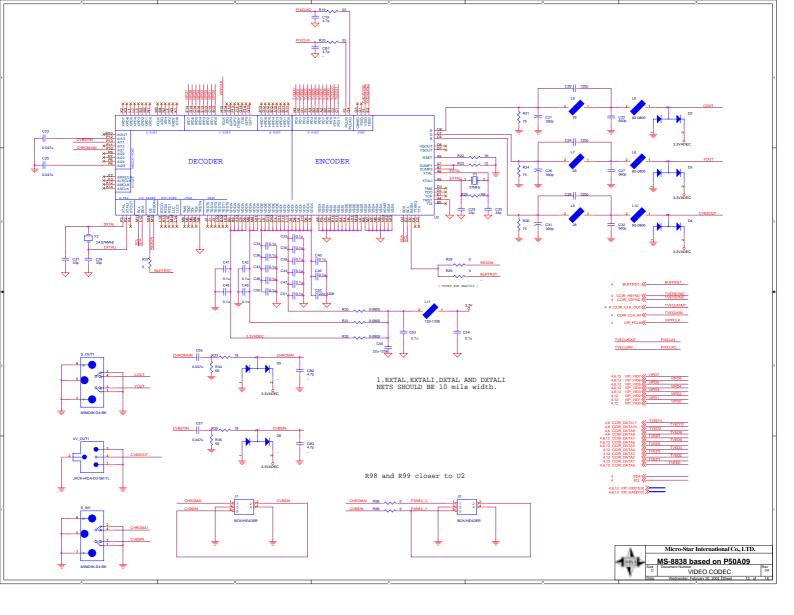


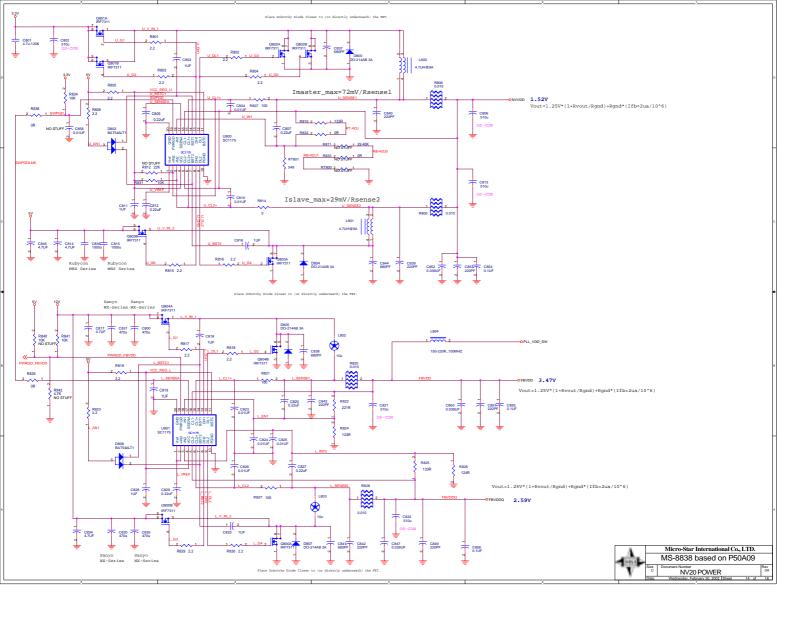


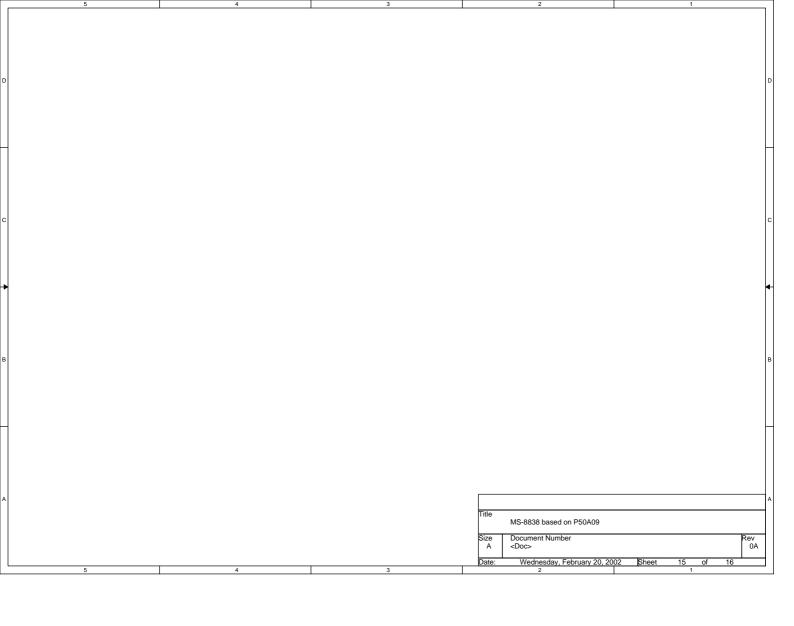












5	4	3	2	1	
P300-1 SCREW P300-2 SCREW	PCB 0.01UF  B-SCREW 0.01UF				D
HEATSINK HEATSINK N_ BRACKET BRACKET					c
3					В
5	4	3	Title  MS-8838 based on P50A09  Size Document Number  A Docs  Date: Wednesday, February 20, 20	Rev 0A 02   Sheet 16 of 16	^